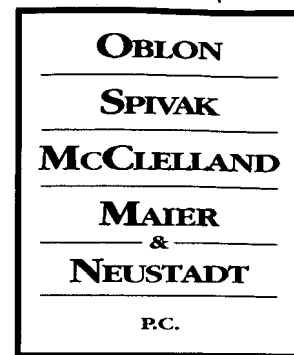




Docket No.: 242751US2

COMMISSIONER FOR PATENTS
ALEXANDRIA, VIRGINIA 22313



ATTORNEYS AT LAW

RE: Application Serial No.: 10/660,605
Applicants: Joichiro EZAKI, et al.
Filing Date: September 12, 2003
For: MAGNETORESISTIVE EFFECT ELEMENT,
MAGNETIC MEMORY DEVICE AND METHOD OF
FABRICATING THE SAME
Group Art Unit: 2824
Examiner: DINH, SON T.

SIR:

Attached hereto for filing are the following papers:

**PETITION UNDER 37 C.F.R. § 1.181,
Copies of Information Disclosure Statement, Form PTO 1449, European Search Report, Cited
Reference (1) and Date Stamped Filing Receipt (as filed on September 30, 2004)**

Our check in the amount of -0- is attached covering any required fees. In the event any variance exists between the amount enclosed and the Patent Office charges for filing the above-noted documents, including any fees required under 37 C.F.R. 1.136 for any necessary Extension of Time to make the filing of the attached documents timely, please charge or credit the difference to our Deposit Account No. 15-0030. Further, if these papers are not considered timely filed, then a petition is hereby made under 37 C.F.R. 1.136 for the necessary extension of time. A duplicate copy of this sheet is enclosed.

Respectfully submitted,

OBLON, SPIVAK, McCLELLAND,
MAIER & NEUSTADT, P.C.

Katherine P. Barecchia

Gregory J. Maier

Registration No. 25,599

Customer Number

22850

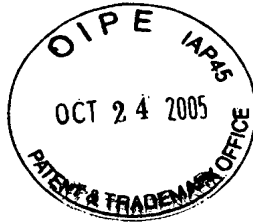
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Katherine P. Barecchia
Registration No. 50,607

DOCKET NO: 242751US2



IN THE UNITED STATES PATENT & TRADEMARK OFFICE

IN RE APPLICATION OF :
JOICHIRO EZAKI, ET AL. : EXAMINER: DINH, SON T.
SERIAL NO: 10/660,605 :
FILED: SEPTEMBER 12, 2003 : GROUP ART UNIT: 2824
FOR: MAGNETORESISTIVE EFFECT :
ELEMENT, MAGNETIC MEMORY
DEVICE AND METHOD OF
FABRICATING THE SAME

PETITION UNDER 37 C.F.R. § 1.181

COMMISSIONER FOR PATENTS
ALEXANDRIA, VIRGINIA 22313

SIR:

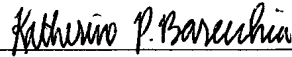
Applicants herein petition the Commissioner to invoke his supervisory authority to require the Examiner to consider the references cited in the Information Disclosure Statement filed on September 30, 2004.

An Information Disclosure Statement in conformity with the requirements of 37 C.F.R. § 1.97 was filed on September 30, 2004. A copy of the Information Disclosure Statement and the date stamped filing receipt are attached. The above-referenced application has now been allowed. Reference AO was not considered by the Examiner.

Although Applicants do not believe that any fee is required for the present petition,
any required fee should be charged to our Deposit Account No. 15-0030.

Respectfully submitted,

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MAIER & NEUSTADT, P.C.



Gregory J. Maier
Attorney of Record
Registration No. 25,599

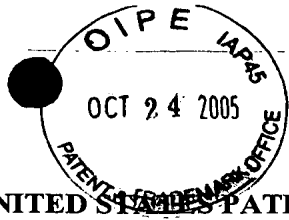
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Docket No. 242751US2/mka



IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

IN RE APPLICATION OF: Joichiro EZAKI, et al.

SERIAL NO: 10/660,605

GAU: 2877

FILED: September 12, 2003

EXAMINER:

FOR: MAGNETORESISTIVE EFFECT ELEMENT, MAGNETIC MEMORY DEVICE AND METHOD OF FABRICATING THE SAME

INFORMATION DISCLOSURE STATEMENT UNDER 37 CFR 1.97

COMMISSIONER FOR PATENTS
ALEXANDRIA, VIRGINIA 22313

SIR:

Applicant(s) wish to disclose the following information.

REFERENCES

- ☒ The applicant(s) wish to make of record the references cited in the attached European Search Report listed on the attached form PTO-1449. Copies of the listed references are attached, where required, as are either statements of relevancy or any readily available English translations of pertinent portions of any non-English language references.
- ☐ A check or credit card payment form is attached in the amount required under 37 CFR §1.17(p).

RELATED CASES

- ☐ Attached is a list of applicant's pending application(s), published application(s) or issued patent(s) which may be related to the present application. In accordance with the waiver of 37 CFR 1.98 dated September 21, 2004, copies of the cited pending applications are not provided. Cited published and/or issued patents, if any, are listed on the attached PTO form 1449.
- ☐ A check or credit card payment form is attached in the amount required under 37 CFR §1.17(p).

CERTIFICATION

- ☐ Each item of information contained in this information disclosure statement was first cited in any communication from a foreign patent office in a counterpart foreign application not more than three months prior to the filing of this statement.
- ☐ No item of information contained in this information disclosure statement was cited in a communication from a foreign patent office in a counterpart foreign application or, to the knowledge of the undersigned, having made reasonable inquiry, was known to any individual designated in 37 CFR §1.56(c) more than three months prior to the filing of this statement.

DEPOSIT ACCOUNT

- ☒ Please charge any additional fees for the papers being filed herewith and for which no check or credit card payment is enclosed herewith, or credit any overpayment to deposit account number 15-0030. A duplicate copy of this sheet is enclosed.

Respectfully submitted,

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ATTY DOCKET NO.

242751US2

SERIAL NO.

10/660,605

LIST OF REFERENCES CITED BY APPLICANT

APPLICANT

Joichiro EZAKI, et al.

FILING DATE

September 12, 2003

GROUP

2877

U.S. PATENT DOCUMENTS

EXAMINER INITIAL		DOCUMENT NUMBER	DATE	NAME	CLASS	SUB CLASS	FILING DATE IF APPROPRIATE
	AA	6,404,674	06/11/2002	T. C. ANTHONY, et al.			
	AB						
	AC						
	AD						
	AE						
	AF						
	AG						
	AH						
	AI						
	AJ						
	AK						
	AL						
	AM						
	AN						

FOREIGN PATENT DOCUMENTS

		DOCUMENT NUMBER	DATE	COUNTRY	TRANSLATION	
					YES	NO
	AO	1 107 329	06/13/2001	EUROPE		
	AP					
	AQ					
	AR					
	AS					
	AT					
	AU					
	AV					

OTHER REFERENCES (Including Author, Title, Date, Pertinent Pages, etc.)

	AW	
	AX	
	AY	
	AZ	

☐ Additional References sheet(s) attached

Examiner

Date Considered

*Examiner: Initial if reference is considered, whether or not citation is in conformance with MPEP 609; Draw line through citation if not in conformance and not considered. Include copy of this form with next communication to applicant.

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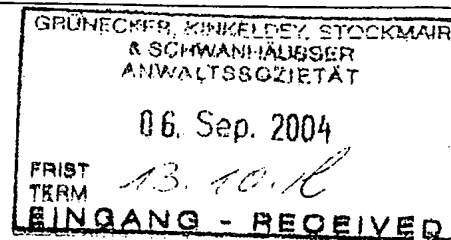
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ALLEMAGNE



Datum/Date

3. 09. 2004

Zeichen/Ref./Réf. EP28561-045/Peu	Anmeldung Nr./Application No./Demande n°/Patent Nr./Patent No./Brevet n° 03020793.0-2210/
Anmelder/Applicant/Demandeur/Patentinhaber/Proprietor/Titulaire TDK Corporation	

COMMUNICATION

The European Patent Office herewith transmits the partial European search report under Rule 46(1) EPC relating to the above-mentioned European patent application.

Copies of the documents cited in the search report are enclosed.

The applicant's attention is drawn to the following:

The search Division informs the applicant that if the European search report is also to cover inventions other than the invention first mentioned in the claims, a further search fee must be paid for each of these inventions, within ONE MONTH after notification of this communication.

If the application has been filed up to 30 June 1999, the search fee in force before 01 July 1999 (EUR 869,-) or the equivalent applicable on the date of payment is payable.
This applies also to the search fees requested under Rule 46(1) EPC.
See also OJ EPO 06/1999, 405.

- ☐ The abstract was modified by the Search Division and the definitive text is attached to the present communication.
- ☐ Additional set(s) of copies of the documents cited in the European search report is (are) enclosed as well.



Note to users of the automatic debiting procedure:

Unless the EPO receives prior instructions to the contrary, the search fee(s) will be debited on the last day of the period for payment. For further details see the Arrangements for the automatic debiting procedure, Supplement to OJ EPO 02/1999.

REGISTERED LETTER

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European Patent
Office

PARTIAL EUROPEAN SEARCH REPORT

under Rule 46, paragraph 1 of the European Patent Convention

Application Number

EP 03 02 0793

DOCUMENTS CONSIDERED TO BE RELEVANT

Category	Citation of document with indication, where appropriate, of relevant passages	Relevant to claim	CLASSIFICATION OF THE APPLICATION (Int.Cl.7)
① Y A	US 6 404 674 B1 (SHARMA MANISH ET AL) 11 June 2002 (2002-06-11) * column 10, line 49 - column 15, line 25 *	1,14 5-13, 15-30	G11C11/16
② Y	EP 1 107 329 A (SHARP KK) 13 June 2001 (2001-06-13) * paragraph '0054! - paragraph '0093! *	1,14	
			TECHNICAL FIELDS SEARCHED (Int.Cl.7)
			G11C

LACK OF UNITY OF INVENTION

The Search Division considers that the present European patent application does not comply with the requirements of unity of invention and relates to several inventions or groups of inventions, namely:

see sheet B

The present partial European search report has been drawn up for those parts of the European patent application which relate to the invention first mentioned in the claims.

Place of search	Date of completion of the search	Examiner
The Hague	30 August 2004	Degraeve, L

CATEGORY OF CITED DOCUMENTS

X : particularly relevant if taken alone
Y : particularly relevant if combined with another document of the same category
A : technological background
O : non-written disclosure
P : intermediate document

T : theory or principle underlying the invention
E : earlier patent document, but published on, or after the filing date
D : document cited in the application
L : document cited for other reasons
& : member of the same patent family, corresponding document



European Patent
Office

LACK OF UNITY OF INVENTION
SHEET B

Application Number
EP 03 02 0793

The Search Division considers that the present European patent application does not comply with the requirements of unity of invention and relates to several inventions or groups of inventions, namely:

1. claims: 1-30,34

MR element composed of among others a plurality of ferromagnetic layers one of which is a closed ring inside which at least two writing conductors run parallelly.

2. claims: 31-33

Fabrication of parallelly running writing conductors in a annular type MR element.

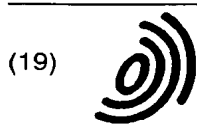
**ANNEX TO THE EUROPEAN SEARCH REPORT
ON EUROPEAN PATENT APPLICATION NO.**

EP 03 02 0793

This annex lists the patent family members relating to the patent documents cited in the above-mentioned European search report. The members are as contained in the European Patent Office EDP file on
The European Patent Office is in no way liable for these particulars which are merely given for the purpose of information.

30-08-2004

Patent document cited in search report		Publication date	Patent family member(s)		Publication date
US 6404674	B1	11-06-2002	CN	1379408 A	13-11-2002
			EP	1248265 A2	09-10-2002
			JP	2003007985 A	10-01-2003
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(19)

Europäisches Patentamt

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(11)

EP 1 107 329 A2

(12)

EUROPEAN PATENT APPLICATION

(43) Date of publication:

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(51) Int Cl.7: H01L 43/08, G11C 11/16,
H01F 10/32

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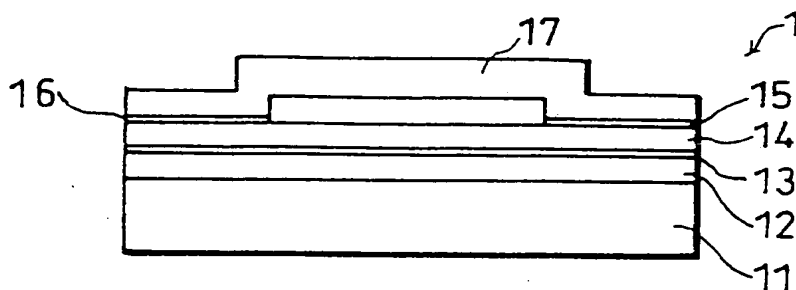
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(54) Magnetic tunnel junction device, magnetic memory adopting the same, magnetic memory cell and access method of the same

(57) A closed magnetic circuit layer is formed on a ferromagnetic layer serving as a memory layer of a magnetic tunnel junction device, in such a manner that a

closed magnetic circuit layer is formed via a metal layer with a spacing at a central portion. With this structure, stable magnetization state can be ensured even for a miniaturized pattern.

FIG.1



COPY

Description

FIELD OF THE INVENTION

[0001] The present invention relates to a magnetic tunnel junction device, a magnetic memory adopting the magnetic tunnel junction device, a magnetic memory cell and an access method of the magnetic memory cell.

BACKGROUND OF THE INVENTION

[0002] Magnetic tunnel junction (MTJ) devices are known to output a signal of a higher level as compared to conventional anisotropic magnetoresistive (AMR) effect devices and giant magnetoresistive (GMR) effect devices. For this beneficial features of the magnetic tunnel junction (MTJ) devices, their applications to reproducing head for hard disk drives (HDDs) or magnetic memories have been considered.

[0003] Especially, in the magnetic memories, the MTJ devices are solid memory of no active section like the semiconductor memories. However, the MTJ devices are advantageous over the semiconductor memories for their beneficial features: a) information stored therein will not be lost in an event of power shut off, b) rewriting of information is permitted unlimited number of times, c) even with an applied radioactive ray, the information stored therein would not be lost.

[0004] An example structure of conventional MTJ device is shown in Figure 11. Such structure is, for example, disclosed by Japanese Unexamined Patent Publication No. 106514/1997 (*Tokukaihei* 9-106514, published on April 22, 1997).

[0005] As shown in Figure 11, an MTJ device 104 includes an antiferromagnetic layer 141, a ferromagnetic layer 142, an insulating layer 143, and a ferromagnetic layer 144 which are laminated in this order. Both the ferromagnetic layer 142 and the ferromagnetic layer 144 have in-plane magnetizations which show such effective uniaxial magnetic anisotropy that the respective magnetizations are parallel to or antiparallel to one another. The magnetization of the ferromagnetic layer 142 is fixed in substantially one direction by an exchange coupling with the antiferromagnetic layer 141, and thus information is recorded thereon in a magnetization direction of the ferromagnetic layer 144.

[0006] For the antiferromagnetic layer 141, FeMn, NiMn, PtMn or IrMn alloy may be adopted. For the ferromagnetic layer 142 and the ferromagnetic layer 144, Fe, Co, Ni, or alloys thereof may be adopted. For the insulating layer 143, various kinds of oxides, nitrides, etc., may be used. However, it is known that the highest magnetoresistance (MR) can be obtained when adopting an Al₂O₃ film for the insulating layer 143.

[0007] Another MTJ device has been proposed of a structure without the antiferromagnetic layer 141, which utilizes a difference in coercive force between the ferromagnetic layer 142 and the ferromagnetic layer 144.

[0008] An operation mechanism of a magnetic memory application of the described MTJ device 104 of Figure 11 is shown in Figures 12(a) and 12(b).

[0009] As described, both the ferromagnetic layer 142 and the ferromagnetic layer 144 have in-plane magnetization and show such effective uniaxial magnetic anisotropy that the respective magnetization are parallel to or antiparallel to one another.

[0010] The magnetization of the ferromagnetic layer 142 is fixed in substantially one direction by an exchange coupling with the antiferromagnetic layer 141, and a recording is performed based on the magnetization direction of the ferromagnetic layer 144.

[0011] Reading out operation is performed by detecting a resistance of the MTJ device 104 which differs depending on whether the magnetization of the memory layer of the ferromagnetic layer 144 and the magnetization of the ferromagnetic layer 142 are parallel to or antiparallel to each other.

[0012] Figure 13 shows a schematic structure of a randomly accessible magnetic memory adopting the MTJ device of Figure 11. The magnetic memory includes a transistor 151 for selecting an MTJ device 152 when reading out. The respective information represented by "0" and "1" are recorded based on the magnetization direction of the ferromagnetic layer 144 of the MTJ device 104 shown in Figure 11. Then, information are read out utilizing the feature that the resistance value is low when the magnetization of the ferromagnetic layer 142 and the magnetization of the ferromagnetic layer 144 are parallel to one another, while the resistance value is high when the respective magnetization are antiparallel to one another.

[0013] On the other hand, recording is performed by inverting the magnetization direction of the ferromagnetic layer 144 by a synthetic magnetic field formed by a bit line 153 and a word line 154. A reference numeral 155 in Figure 13 indicates a plate line.

[0014] In the described MTJ device 104, however, magnetic poles generate at both end portions due to the in-plane magnetization of the ferromagnetic layer 142 and the antiferromagnetic layer 144. In order to meet a demand for high density magnetic memory, a miniaturization of the MTJ device 104 is necessary. However, the miniaturization of the MTJ device 104 results in a greater effect of the demagnetizing field caused by the magnetic poles generated at both end portions.

[0015] The ferromagnetic layer 142 which is exchange coupled with the antiferromagnetic layer 141 is not affected much by the described demagnetizing field. Further, as disclosed in US Patent No. 5,841,692, the magnetic poles generated at both end portions can be substantially eliminated.

[0016] However, the same cannot be applied to a memory layer of the ferromagnetic layer 144, and as the pattern is miniaturized, the magnetization becomes more unstable due to the magnetic poles generated at both end portions, thereby making it difficult to maintain

the initial recorded state.

[0017] In order to counteract the foregoing problem, attempts have been made to suppress the effects of the magnetic poles at both end portions by arranging the memory layer of the ferromagnetic layer 144 so as to have a closed magnetic circuit structure. In this state, by arranging such that both the bit line and the word line are formed in the closed magnetic circuit, the magnetization direction of the ferromagnetic layer 144 can be inverted effectively when recording. However, since the bit line and the word line are formed in the same direction within the MTJ device, it is difficult to adopt the simple orthogonal array as shown in Figure 13. The foregoing closed magnetic circuit structure is disclosed in, for example, Japanese Unexamined Patent Publication No. 302456/1998 (*Tokukaihei* 10-302456, published on November 13, 1998), however, an optimal access method of the magnetic memory cell is not disclosed.

[0018] When applying the MTJ device to the magnetic head or the magnetic memory, it is important to attain a high resistance change ratio. However, an improvement in resistance change ratio by an optimal selection of a material is limited, and thus a method of improving resistance change ratio by modifying the film structure has been considered. For example, Japanese Unexamined Patent Publication No. 163436/1999 (*Tokukaihei* 11-163436, published on June 18, 1999) realizes a high resistance change ratio by laminating a plurality of MTJ devices.

[0019] The structure of the MTJ device of Japanese Unexamined Patent Publication No. 163436/1999 is shown in Figure 14. As shown in Figure 14, the MTJ device includes a first ferromagnetic layer 161, a first insulating layer 162, a second magnetic layer 163, a second insulating layer 164 and a third magnetic layer 165 which are laminated in this order. The described MTJ device is mainly designed for the magnetic head; however, it can be also applied to magnetic memory.

[0020] In the case of applying the MTJ device of the structure shown in Figure 14, the arrangement wherein the ferromagnetic layer 161, the ferromagnetic layer 163 and the ferromagnetic layer 165 all show in-plane magnetization which show such effective uniaxial magnetic anisotropy that the respective magnetization are parallel to or antiparallel to one another.

[0021] The respective magnetization of the ferromagnetic layer 161 and the ferromagnetic layer 165 are fixed in substantially one direction by the exchange coupling with the antiferromagnetic layer, and information is recorded based on the magnetization of the ferromagnetic layer 163. On the other hand, reading out of information is performed by detecting the resistance of the MTJ device which differs depending on whether the magnetization of the memory layer of the ferromagnetic layer 163 is parallel or antiparallel to other ferromagnetic layers 161 and 165. According to the structure shown in Figure 14, the magnetic tunnel junction sections are connected in series, and thus, can output a signal of a level twice

as high as the conventional MTJ device with a single magnetic tunnel junction section.

[0022] Writing is performed by changing a magnetization direction of the ferromagnetic layer 163 by utilizing a magnetic field generated by a current line disposed in a vicinity of the MTJ device.

[0023] In the described MTJ device also, the ferromagnetic layer 161, the ferromagnetic layer 163 and the ferromagnetic layer 165 have in-plane magnetization, and thus magnetic poles generate at both end portions. In order to realize high density magnetic memory, it is required to miniaturize the MTJ device. However, the miniaturization of the MTJ device results in a greater effect of the demagnetizing field caused by the magnetic poles generated at both end portions.

[0024] In the case where the ferromagnetic layers 161 and 165 are exchange coupled with the antiferromagnetic layer, the demagnetizing field is not affected much. By constituting the ferromagnetic layers 161 and 165 with two ferromagnetic layers which are exchange coupled, magnetic poles generated at both end portions are substantially zero.

[0025] However, the same cannot be applied to a memory layer of the ferromagnetic layer 163, and as the pattern is miniaturized, the magnetization becomes more unstable due to the magnetic poles generated at both end portions, thereby making it difficult to maintain the initial recorded state.

30 SUMMARY OF THE INVENTION

[0026] It is an object of the present invention to provide a magnetic tunnel junction device which can maintain a magnetization recorded in a memory layer under stable condition even for a miniaturized pattern, and a magnetic memory adopting the same.

[0027] It is another object of the present invention to provide an access method of a magnetic memory which permits a closed magnetic circuit structure to be introduced in a ferromagnetic layer of a memory layer without reducing a cell density of a magnetic memory.

[0028] In order to achieve the above object, the magnetic tunnel junction device of the present invention including at least a first magnetic layer, an insulating layer and a second magnetic layer which are laminated in this order, is characterized by further including:

a third magnetic layer formed on an opposite side of an insulating layer forming side of the first or second magnetic layer via a metal layer with a spacing at a central portion, wherein the first or second magnetic layer and the third magnetic layer form a closed magnetic circuit.

[0029] According to the foregoing arrangement, the magnetization of the third magnetic layer serving as the closed magnetic circuit layer and the first or second magnetic layer form a closed loop; and thus the gener-

ation of the magnetic poles at both end portions can be avoided. As described, according to the MTJ device of the described structure, effects of the magnetic poles generated at both end portions can be avoided. Thus, a stable magnetization state as recorded can be maintained even for a miniaturized pattern. Additionally, since the memory layer of the ferromagnetic layer has a closed magnetic circuit structure, stable magnetization state as recorded can be ensured against an external leakage magnetic field.

[0030] In order to achieve the above object, a magnetic memory of the present invention is characterized by adopting a magnetic tunnel junction device including at least a first magnetic layer, an insulating layer and a second magnetic layer which are laminated in this order, and a third magnetic layer formed on an opposite side of an insulating layer forming side of the first or second magnetic layer via a metal layer with a spacing at a central portion, wherein the first or second magnetic layer and the third magnetic layer form a closed magnetic circuit.

[0031] According to the forgoing arrangement, the magnetization of the third magnetic layer serving as the closed magnetic circuit layer and the first or second magnetic layer form a closed loop; and thus the generation of the magnetic poles at both end portions can be avoided. As described, according to the MTJ device of the described structure, effects of the magnetic poles generated at both end portions can be eliminated. Thus, a stable magnetization state as recorded can be maintained for a miniaturized pattern. Additionally, since the memory layer of the ferromagnetic layer has a closed magnetic circuit structure, a stable magnetization state as recorded can be ensured against an external leakage magnetic field. Therefore, a power consumption of the magnetic memory adopting the MTJ device can be reduced.

[0032] In order to achieve the above object, another magnetic tunnel junction device of the present invention including a first magnetic layer, a first insulating layer, a second magnetic layer, a second insulating layer and a third magnetic layer which are laminated, is characterized by further including:

a fourth magnetic layer formed on either a first insulating layer forming side or a second insulating layer forming side of the second magnetic layer via a metal layer with a spacing at a central portion, wherein:

the second magnetic layer and the fourth magnetic layer form a closed magnetic circuit.

[0033] According to the described arrangement, a high resistance change ratio can be obtained, and the effects of the magnetic poles generated at both end portions can be reduced. Thus, a stable magnetization state as recorded can be maintained even for a miniaturized pattern. Additionally, since the memory layer of

the ferromagnetic layer has a closed magnetic circuit structure, stable magnetization state as recorded can be ensured against an external leakage magnetic field.

[0034] In order to achieve the above object, another magnetic memory of the present invention is characterized by including: a first magnetic layer, a first insulating layer, a second magnetic layer, a second insulating layer and a third magnetic layer which are laminated, and further include a fourth magnetic layer formed either a first insulating layer forming side or a second insulating layer forming side of the second magnetic layer via a metal layer with a spacing formed at a central portion, wherein the second magnetic layer and the fourth magnetic layer form a closed magnetic circuit.

[0035] According to the described arrangement, a high resistance change ratio can be obtained, and the effects of the magnetic poles generated at both end portions can be reduced. Thus, a stable magnetization state as recorded can be maintained for a miniaturized pattern. As a result, a magnetic memory of an improved integration can be realized, and a power consumption of the magnetic memory can be reduced.

[0036] In order to achieve the above object, an access method of a magnetic memory cell of the present invention is characterized by including the steps of:

forming a closed magnetic circuit on a magnetic layer for storing a memory of a magnetic memory cell; placing a first current line (bit line) in a closed magnetic circuit composed of the magnetic layer and the closed magnetic circuit layer, and a second current line (word line) outside the closed magnetic circuit; changing the magnetization direction of the magnetic layer by applying such current to the first current line that the magnetization of the closed magnetic circuit layer is inverted but the magnetization of the magnetic layer is not inverted, and applying such current to the second current line that the magnetization of the magnetic layer is not inverted by the second current line alone, but the magnetization of the magnetic layer is inverted by a synthetic magnetic field with the first current line.

[0037] According to the described access method of the magnetic memory cell, by controlling the magnetic characteristics of the ferromagnetic layer and the closed magnetic circuit layer and the level of current flowing through the first current line (bit line) and the second current line (word line), access to only one magnetic memory cell is permitted, and a required recording current can be reduced. Further, the effects of magnetic poles at both end portions on the magnetic memory cell can be suppressed. As a result, a stable magnetization state can be ensured even for a miniaturized pattern, and a highly integrated magnetic memory can be realized. Additionally, by adopting the closed magnetic circuit layer structure for the memory layer, a stable magnetization state as recorded can be ensured against an

external leakage magnetic field. Further, a power consumption of the magnetic memory can be reduced.

[0038] Further, the first current line is formed within the closed magnetic circuit layer structure formed by the magnetic layer and the closed magnetic circuit layer, the magnetization of the closed magnetic circuit layer can be inverted at sufficiently low current, thereby effectively applying the magnetic layer.

[0039] For a fuller understanding of the nature and advantages of the invention, reference should be made to the ensuing detailed description taken in conjunction with the accompanying drawings.

BRIEF DESCRIPTION OF THE DRAWINGS

[0040] Figure 1 is an explanatory view showing a schematic structure of an MTJ device in accordance with one embodiment of the present invention.

[0041] Figure 2 is an explanatory view showing a schematic structure of a magnetic memory adopting the MTJ device of Figure 1.

[0042] Figure 3 is an explanatory view showing an arrangement of a word line and a bit line of the magnetic memory shown in Figure 2.

[0043] Figure 4 is an explanatory view showing a schematic structure of the MTJ device in accordance with another embodiment of the present invention.

[0044] Figure 5 is an explanatory view showing a schematic structure of the magnetic memory adopting the MTJ device shown in Figure 4.

[0045] Figure 6 is an explanatory view showing an arrangement of a word line and a bit line of the magnetic memory adopting the MTJ device of the present invention.

[0046] Figure 7 is an explanatory view showing a schematic structure of an MTJ device in accordance with still another embodiment of the present invention.

[0047] Figure 8 is an explanatory view showing one example of a magnetic memory cell of the present invention.

[0048] Figure 9 is an explanatory view showing a schematic structure of another example of a magnetic memory cell of the present invention.

[0049] Figure 10 is an explanatory view showing a schematic structure of another example of a magnetic memory cell of the present invention.

[0050] Figure 11 is an explanatory view showing a structure of a conventional MTJ device.

[0051] Figure 12(a) and Figure 12(b) are explanatory views showing a conventional MTJ device operation mechanism adopted in a magnetic memory.

[0052] Figure 13 is an explanatory view showing a schematic structure of a conventional magnetic memory.

[0053] Figure 14 is an explanatory view showing a schematic structure of a conventional MTJ device.

DESCRIPTION OF THE EMBODIMENTS

[FIRST EMBODIMENT]

[0054] The following descriptions will discuss one embodiment of the present invention in reference to figures.

[0055] As shown in Figure 1, the MTJ device 1 of the present embodiment includes: an antiferromagnetic layer 11, a ferromagnetic layer 12, an insulating layer 13, a ferromagnetic layer 14, metal layers 15 and 16, closed magnetic circuit layer 17 (third magnetic layer). The antiferromagnetic layer 11 and the magnetic layer 17 are exchange coupled. The ferromagnetic layer 14 and the closed magnetic circuit layer 17 are connected at both sides via the metal layers 15 and 16, while separated in the central part. Either of the magnetic layer 12 or the magnetic layer 14 corresponds to the first magnetic layer, and the other corresponds to the second magnetic layer. The closed magnetic circuit layer 17 corresponds to the third magnetic layer.

[0056] For the material of the antiferromagnetic layer 11, FeMn, NiMn, PtMn or IrMn alloy may be adopted. For the material of the ferromagnetic layers 12 and 14 and the closed magnetic circuit layer 17, Fe, Co or Ni alloy may be adopted. For the material of the insulating layer 13, the Al_2O_3 film is the most preferable in view of magnetoresistance (MR). However, the material of the insulating layer 13 is not limited to be above, and, for example, oxides, nitrides, may be adopted. Or the insulating layer 13 made of Si, diamond, or diamond like carbon (DLD) film may be adopted.

[0057] For the metal layer 15, Ru, Cr, or Cu or alloys thereof may be adopted. The thickness of the metal layer 15 is set such that antiferromagnetic coupling is exerted between the ferromagnetic layer 14 and the closed magnetic circuit layer 17. In this state, since respective magnetization of the ferromagnetic layer 14 and the closed magnetic layer 17 form a closed loop (closed magnetic circuit), generation of magnetization at the end portions can be avoided.

[0058] It is preferable that the thickness of the ferromagnetic layers 12, 14 and the closed magnetic circuit layer 17 be in a range of from 10 Å to 1000 Å. If these films are too thin, superparamagnetism occurs, and thus, the magnetic layer desirably has thickness of not less than 10 Å. On the other hand, if the film is too thick, in the closed circuit structure of the present invention, the effects of the magnetic poles at both end portions cannot be avoided, and thus it is desirable that the magnetic layer has a thickness in a range of not more than 1000 Å. Each magnetic layer may be constituted by a plurality of films, and in this case, it is desirable that the total thickness is set in a range of not less than 10 Å to not more than 1000 Å.

[0059] It is preferable that the thickness of the insulating film 13 be in a range of from 3 Å to 30 Å. If the insulating layer 13 has a thickness of not more than 3 Å, the ferromagnetic layer 12 and the ferromagnetic layer

er 14 may be electrically shorted. On the other hand, if the insulating layer 13 has a thickness of not less than 30 Å, tunnel of electron is less likely to occur, and the magnetoresistance ratio would be lowered.

[0060] In the structure shown in Figure 1, the metal layers 15 and 16 are separately provided. However, it is obvious that a continuous metal layer of a single structure in replace of the metal layers 15 and 16 also enables the object of the present invention to be achieved.

[0061] Figure 2 is a schematic view of the MTJ device 1 adopted in a randomly accessible magnetic memory 2.

[0062] The transistor 21 is provided for selecting the MTJ device 1 when reading out. Information indicated by "0" and "1" are recorded based on the magnetization direction of the ferromagnetic layer 14 of the MTJ device 1 shown in Figure 1, and the magnetization direction of the ferromagnetic layer 12 is fixed. The information are read out utilizing such magnetic resistance effects that the resistance of the MTJ device 1 is low when respective magnetizations of the ferromagnetic layer 12 and the ferromagnetic layer 14 are in parallel, while the resistance of the MTJ device 1 is high when the respective magnetizations are in antiparallel. On the other hand, information are written by inverting respective magnetization directions of the ferromagnetic layer 14 and the closed magnetic circuit layer 17 by a synthetic magnetic field formed by the bit line 22 (lead line) and the word line 23 (lead line).

[0063] Example arrangements of the bit line 22 and the word line 23 are shown in Figure 3. In the figure, the reference numeral 24 shows a plate line. Here, by passing the bit line 22 and the word line 23 in a spacing formed at a central part between the ferromagnetic layer 14 and the closed magnetic circuit layer 17, a current value required for inverting the directions of the respective magnetizations of the ferromagnetic layer 14 and the closed magnetic circuit layer 17 can be reduced, thereby permitting power consumption of the magnetic memory to be reduced.

[0064] The respective arrangements of the bit line and the word line are not limited to the arrangement shown in Figure 3. For example, the bit line and the word line may be formed on the same plane. Or, either one of the bit line or the word line may be formed on the same plane. Or, both of or either one of the lines may be formed to the exterior but close to the MTJ device. In this way, the process can be simplified.

[0065] In Figure 3, both the bit line 22 and the word line 23 are electrically insulated from the ferromagnetic layer 14 and the closed magnetic circuit layer 17. However, the present invention is not limited to this arrangement, and it may be arranged such that either one of the bit line 22 or the word line 23 is electrically connected to the ferromagnetic layer 17, to detect variations in resistance.

[0066] In the foregoing descriptions, the magnetization of the ferromagnetic layer 12 is fixed by the exchange coupling with the antiferromagnetic layer 11. Al-

ternatively, a ferromagnetic material of a large coercive force may be adopted in order to fix the magnetization of the ferromagnetic layer 12.

[0067] By adopting two ferromagnetic layers which are antiferromagnetically coupled via the metal layer, effects of the magnetic pole generated at the end portions of the ferromagnetic layer 12 can be reduced. Alternatively, when adopting the ferromagnetic material like rare-earth-transition metal alloy of a composition near the compensation point, the effects of the magnetic pole at the end portion can be reduced.

[0068] The respective layers of the present embodiment may be laminated in the reversed order. Also, although explanations have been given through the case of adopting the closed magnetic circuit structure formed in one of the ferromagnetic layer. However, the present invention is not limited to this, and

[SECOND EMBODIMENT]

[0069] The following descriptions will discuss another embodiment of the present invention in reference to figures.

[0070] Figure 4 shows a schematic structure of an MTJ device of the present embodiment.

[0071] As shown in Figure 4, an MTJ device 3 of the present embodiment includes an antiferromagnetic layer 31 (first antiferromagnetic layer), a ferromagnetic layer 32, an insulating layer 33, a ferromagnetic layer 34 (second magnetic layer), metal layers 35, 35', a ferromagnetic layer (closed magnetic circuit layer, fourth magnetic layer) 36, an insulating layer 37, a ferromagnetic layer 38 and an antiferromagnetic layer 39 (second antiferromagnetic layer). The ferromagnetic layer 34 and the antiferromagnetic layer (closed magnetic circuit layer) 36 are connected via the metal layers 35, 35' and are separated at the central portion.

[0072] In the above arrangement, by setting the film thickness of the metal layers 35, 35' such that an antiferromagnetic complying is exerted between the ferromagnetic layer 34 and the ferromagnetic layer (closed magnetic circuit layer) 36, the respective magnetization directions of the antiferromagnetic layer 34 and the ferromagnetic layer (closed magnetic circuit layer) 36 can be made opposite to each other. Therefore, the respective magnetization of the ferromagnetic layer 34 and the ferromagnetic layer (closed magnetic layer) 36 form a closed loop, and thus generation of a magnetic wall at the both end parts of the ferromagnetic layer 34 can be avoided.

[0073] The antiferromagnetic layer 31 and the ferromagnetic layer 32, and the antiferromagnetic layer 39 and the ferromagnetic layer 38 are exchange coupled respectively, and the magnetization directions of the ferromagnetic layer 32 and the ferromagnetic layer 38 are fixed.

[0074] For materials of the ferromagnetic layers 32, 34 and 38, and the closed magnetic circuit layer 36, Fe,

Co, Ni or alloys thereof may be adopted. For the materials of the antiferromagnetic layers 31 and 39, alloys of FeMn, NiMn, PtMn, IrMn, etc., may be adopted.

[0075] For insulating layers 33 and 37, the Al_2O_3 film is the most preferable in view of magnetoresistance (MR). However, the material of the insulating layer 13 is not limited to be above, and, for example, oxides, nitrides, may be adopted. Or the insulating layer 13 made of Si, diamond, or diamond like carbon (DLD) film may be adopted. For the metal layers 35, 35', Ru, Cr, Cu, etc., or alloys thereof may be adopted.

[0076] In the described MTJ device 3, information are recorded based on the magnetization direction of the closed loop formed by the ferromagnetic layer 34 and the ferromagnetic layer (closed magnetic layer) 36. On the other hand, reproducing of information is performed based on changes in resistance depending on whether the magnetization direction of the ferromagnetic layers 32 and 38 (fixed layers) and the magnetization direction of the closed loop formed by the ferromagnetic layer 34 and the ferromagnetic layer (closed magnetic circuit layer) 36 are parallel or antiparallel.

[0077] As described, the recorded information are stored based on the magnetization direction of the closed loop formed by the ferromagnetic layer 34 and the ferromagnetic layer (closed magnetic circuit layer) 36. This means that the respective magnetization of the ferromagnetic layers 32 and 38 are needed to be fixed in opposite directions by the antiferromagnetic layer 31 and the antiferromagnetic layer 39.

[0078] Such magnetization can be realized by adopting materials of different temperatures (blocking temperature) T_b at which exchange coupled magnetic field loses for the antiferromagnetic layers 31 and 39.

[0079] For example, explanations will be given through the case of adopting the PtMn film for the antiferromagnetic layer 31, and the IrMn film for the antiferromagnetic layer 39. PtMn is an antiferromagnetic layer of an order phase of AuCuI type, and its T_b is 380 °C. On the other hand, IrMn is an antiferromagnetic member having a face-centered cubic structure, and T_b is 270 °C.

[0080] After molding all the layers (21 to 29) under vacuum condition, a heat treatment is applied for 6 hours at 250 °C while applying a magnetic field in a direction of ordering the antiferromagnetic layer 31 composed of the PtMn film. As a result, the PtMn film (antiferromagnetic layer 31) is ordered, and its spin is aligned in the process of cooling off while having an effect of magnetization of the ferromagnetic layer 32 in which its spin is aligned in the magnetic field application direction. By the resulting exchange coupling, the ferromagnetic layer 32 is fixed in the direction the magnetic field is applied.

[0081] Next, heat is applied to temperatures in a range of not less than T_{b2} and not more than T_{b1} , and cooling is performed while applying a magnetic field in an opposite direction (180 °) from the original state. As

a result, the spin of the antiferromagnetic layer composed of IrMn film is realigned in the process of cooling off having an effect of the magnetization of the adjacent ferromagnetic layer 38 to which the magnetic field in the opposite direction is applied, and is fixed in antiparallel direction to that of the initial heating process.

[0082] As the temperature is not more than T_{b1} , the direction of the magnetic field of the exchange coupling between the antiferromagnetic layer 31 composed of PtMn film and the ferromagnetic layer 32 is not affected, and the magnetization of the ferromagnetic layer 32 is maintained in the direction of the initial heating process, whereby respective magnetization directions of the ferromagnetic layer 32 and the ferromagnetic layer 38 become antiparallel to one another.

[0083] The material and the alignment direction of the antiferromagnetic layer are not limited to the above as long as the two antiferromagnetic layers have different T_b s. Besides i) the heating method in the magnetic field, the foregoing arrangement of magnetization can be realized by ii) controlling the direction of magnetization when forming films, or combination of i) and ii). Needless to mention, when adopting the disorder alloy film for the antiferromagnetic layer, a heat treatment for ordering as required when adopting the order alloy film can be omitted.

[0084] It is preferable that the ferromagnetic layers 32, 34 and 38, and the closed ferromagnetic circuit layer 37 is in a range of from not less than 10 Å to not more than 1000 Å. If these films are too thin, a superparamagnetism occurs, and thus, the magnetic layer desirably has thickness of not less than 10 Å. On the other hand, if the film is too thick, in the closed circuit structure of the present invention, the effects of the magnetic poles at both end portions cannot be avoided, and thus it is desirable that the magnetic layer has a thickness in a range of not more than 1000 Å. Each magnetic layer may be constituted by a plurality of films, and in this case, it is desirable that the total thickness is set in a range of not less than 10 Å to not more than 1000 Å.

[0085] It is also desirable that the insulating layers 33, 37 respectively have thickness in a range of from 3 Å to 30 Å. If the thickness of the insulating layer 33, 37 is not more than 3 Å, the ferromagnetic layer 32 and the ferromagnetic layer 34, or the ferromagnetic layer 36 and the ferromagnetic layer 38 may be electrically shorted. In the case where the thickness of the insulating film 33, 37 is not less than 30 Å, a tunneling of an electron is less likely to occur, and the magnetic resistance ratio becomes smaller.

[0086] In the structure shown in Figure 4, the respective metal layers 35, 35' are separately provided; however, it is needless to mention that a single continuous metal layer may be adopted to realize the object of the present invention.

[0087] Furthermore, by arranging such that the ferromagnetic layer 32 and the ferromagnetic layer 38 are composed of two magnetic layers respectively, the mag-

netic poles generated at both end parts can be eliminated. Even in the case of adopting three or more magnetic layers for each of these magnetic layers, generation of magnetic pole at both end portions may be avoided by adjusting the film thickness of the ferromagnetic layer.

[0088] Next, an example of a randomly accessible magnetic memory 80 adopting the MTJ device 3 of the present embodiment will be explained in reference to Figure 5.

[0089] In Figure 5, the transistor 71 has a function of selecting the MTJ device 3 when reading out. The information represented by "1" and "0" are recorded based on the magnetization directions of the ferromagnetic layer 34 and the ferromagnetic layer (closed magnetic circuit layer) 36 of the MTJ device 3 shown in Figure 4. Information are read out utilizing such characteristics that the resistance value is low when respective magnetization of the ferromagnetic layer 32 and the ferromagnetic layer 34 are parallel, and respective magnetization of the ferromagnetic layer 38 and the ferromagnetic layer (closed magnetic circuit layer) 36 are parallel, while the resistance value is high when the respective magnetization are in antiparallel. On the other hand, information are recorded by inverting the magnetization direction of the ferromagnetic layer 34 and the ferromagnetic layer (closed magnetic circuit layer) 36.

[0090] In Figure 5, the reference numeral 74 indicates a plate line.

[0091] Figure 6 shows an example arrangement of the bit line 72 and the word line 73.

[0092] In Figure 6, by forming the bit line 72 and the word line 73 in a spacing at the central portion between the ferromagnetic layer 34 and the antiferromagnetic layer (closed magnetic circuit layer) 36, a current value required for inverting the magnetization directions of the ferromagnetic layer 34 and the ferromagnetic layer (closed magnetic circuit layer) 36 can be reduced, thereby suppressing power consumption of the magnetic memory.

[0093] Both the bit line 72 and the word line 73 are electrically insulated from the ferromagnetic layer 34 and the ferromagnetic layer (closed magnetic circuit layer) 36.

[THIRD EMBODIMENT]

[0094] The following descriptions will discuss still another embodiment of the present invention in reference to figures.

[0095] Figure 7 shows a schematic structure of an MTJ device of the present embodiment.

[0096] As shown in Figure 7, the MTJ device 4 in accordance with the present embodiment includes an antiferromagnetic layer 41 (first antiferromagnetic layer), a ferromagnetic layer 42 (first magnetic layer), an insulating layer 43 (first insulating layer), a ferromagnetic layer 44 (second magnetic layer), metal layers 45, 45', a ferromagnetic layer (closed magnetic circuit layer),

fourth magnetic layer) 46, an insulating layer 47 (second insulating layer), a ferromagnetic layer 48 (third magnetic layer) and an antiferromagnetic layer 49 (second antiferromagnetic layer). The ferromagnetic layer 44 and the antiferromagnetic layer (closed magnetic circuit layer) 46 are connected via the metal layers 45, 45' at both end parts with a spacing at a central portion.

[0097] In the above arrangement, by setting the film thickness of the metal layers 45, 45' such that an antiferromagnetic coupling is exerted between the ferromagnetic layer 44 and the ferromagnetic layer (closed magnetic circuit layer) 46, the respective magnetization directions of the antiferromagnetic layer 44 and the ferromagnetic layer (closed magnetic circuit layer) 46 can be made opposite to each other. Therefore, the respective magnetization of the ferromagnetic layer 44 and the ferromagnetic layer (closed magnetic circuit layer) 46 form a closed loop, and thus generation of a magnetic wall at both end parts of the ferromagnetic layer 44 can be avoided.

[0098] The MTJ device 4 of the present embodiment differs from the MTJ device 3 of the second embodiment in that the ferromagnetic layer 42 is composed of two ferromagnetic layer 42a (second ferromagnetic layer) and the ferromagnetic layer 42c which are antiferromagnetically coupled via a metal layer 42b (second metal layer), and the ferromagnetic layer 42c (first ferromagnetic layer) which is exchange coupled with the antiferromagnetic layer 41. As in the second embodiment, the antiferromagnetic layer 49 and the ferromagnetic layer 48 are exchange coupled.

[0099] The magnetization of the ferromagnetic layer 48 is fixed by exchange coupling with the antiferromagnetic layer 49. The magnetization of the antiferromagnetic layer 42c is fixed by exchange coupling with the antiferromagnetic layer 41. Further, the ferromagnetic layer 42a is antiferromagnetically coupled via the antiferromagnetic layer 42b, and thus has magnetization in opposite direction to the antiferromagnetic layer 42c.

[0100] The MTJ device 4 records information based on the magnetization direction of a closed loop composed of the antiferromagnetic layer 44 and the antiferromagnetic layer (closed magnetic circuit layer) 46. The MTJ device 4 reads out information based on changes in resistance depending on whether the magnetization direction of the closed loop composed of the ferromagnetic layer 44 and the antiferromagnetic layer (closed magnetic circuit layer) 46 and the magnetization direction of the ferromagnetic layers 42a and 48 are parallel to or antiparallel to one another.

[0101] As described, in order to read out information in the foregoing manner, i.e., based on changes in resistance depending on whether the magnetization direction of the closed loop composed of the ferromagnetic layer 44 and the antiferromagnetic layer (closed magnetic circuit layer) 46 and the magnetization direction of the ferromagnetic layers 42a and 48 are parallel to or antiparallel to one another, it is required to fix the mag-

netization direction of the ferromagnetic layer 42c in the same direction as the antiferromagnetic layer 48.

[0102] According to the foregoing arrangement, the respective magnetizations of the ferromagnetic layer 42c and the ferromagnetic layer 48 can be fixed with a single treatment or a magnetic field of the same direction. As a result, the process of reading out can be simplified as compared to the previous embodiment.

[0103] In the present embodiment, the ferromagnetic layer 42 of a double layer structure, and an ferromagnetic layer 48 of a single layer structure are adopted. However, the present invention is not limited to this arrangement as long as the condition that the respective numbers of magnetic layers differ between the two fixed layers by one.

[0104] In the present embodiment, the same antiferromagnetic material may be used for the antiferromagnetic layer 41 and the antiferromagnetic layer 49.

[0105] The MTJ device 4 of the present embodiment can be used in the magnetic memory as in the MTJ device 3 of the second embodiment.

[0106] In the present embodiment, only the MTJ device portion is shown; however, it is needless to mention that in actual device forming process, the electrode for supplying current, the substrate, the protective layer and an adhesive layer are needed.

[FOURTH EMBODIMENT]

[0107] The following descriptions will discuss still another embodiment of the present invention in reference to figures.

[0108] A magnetic memory adopting an MTJ device in accordance with the present embodiment is shown in Figure 8. As shown in Figure 8, respective magnetic memory cells 51 are disposed at intersections between a bit lines 52 (first current line) and the word lines 53 (second current lines). The magnetic memory cell 51 has the closed magnetic circuit structure in the vertical axis direction in the Figure, and has the magnetization also in the vertical axis direction. Figure 9 shows a cross section cut by a line A-B of Figure 8. For simplification, a single magnetic memory cell is shown.

[0109] As shown in Figure 9, the magnetic memory cell 51 includes a closed magnetic circuit layer 65 formed on the MTJ device composed of an antiferromagnetic layer 61, an ferromagnetic layer 62, an insulating layer 63, and a ferromagnetic layer 64 (magnetic layer). The antiferromagnetic layer 61 and the antiferromagnetic layer 62 are exchange coupled. The ferromagnetic layer 64 and the closed magnetic circuit layer 65 are connected at both end portions, and are separated at the central portion. The bit line 52 is provided in the above spacing in the central portion, and is electrically connected to the MTJ device. The word line 53 is provided on the magnetic memory cell 51 via the insulating layer 66.

[0110] Therefore, one end of the MTJ device is elec-

trically connected to the bit line 52, and the other end is connected to a drain of the selective transistor (not shown). The word line is electrically insulated from the MTJ device and is connected to a gate of a selective transistor (not shown). As a result, randomly accessible layout shown in Figure 5 can be realized.

[0111] The information of the magnetic memory cell are recorded in the magnetization direction of the ferromagnetic layer 64. On the other hand, the magnetization direction of the ferromagnetic layer 62 is fixed by an exchange coupling with the antiferromagnetic layer 61. Therefore, the information recorded in the magnetic memory cell, i.e., the magnetization direction of the ferromagnetic layer is detected based on changes in resistance whether the respective magnetization directions of the ferromagnetic layer 62 and the antiferromagnetic layer 64 are in parallel or in antiparallel.

[0112] The rewriting of information on the magnetic memory cell can be realized by changing the magnetization direction of the ferromagnetic layer 64 by applying current to the bit line 52 and the word line 53. In this state, except for the magnetic memory cell 51 disposed at the intersection between the bit line 52 for flowing therethrough current and the word line 53, the magnetization of the ferromagnetic layer 62 of the magnetic memory cell is needed to be fixed. This condition can be realized, for example, as below-indicated.

[0113] The ferromagnetic layer 64 can store information, and has coercive force that enables rewriting at a recording current. On the other hand, the closed magnetic circuit layer 65 is made of a material having a smaller coercive force than that of the ferromagnetic layer 64. When rewriting information in the magnetic memory cell 51, such current that inverts magnetization of the closed magnetic circuit layer 65 but the magnetization of the ferromagnetic layer 64 is not inverted is applied to the bit line 52. To the word line 53, such current that the synthetic magnetic field with the bit line 52 inverts the magnetization of the ferromagnetic layer 64, but the magnetization of the ferromagnetic layer 64 is not inverted by the word line 53 alone. In this state, the magnetic field from the bit line 52 is not applied to other cells than the magnetic memory cell 51 on the bit line 52, and thus, the magnetization direction of the ferromagnetic layer 42 is not changed.

[0114] As described, by controlling the magnetic characteristics of the ferromagnetic layer 64 and the closed magnetic circuit layer 65 and the level of current applied to the bit line 52 and the word line 53, only the magnetization direction of the magnetic memory cell 51 at the intersection between the bit line 52 and the word line 53 can be changed.

[0115] According to the described arrangement, the bit line 52 is provided in the closed magnetic circuit structure composed of the ferromagnetic layer 64 and the closed magnetic circuit layer 65, the magnetization of the closed magnetic circuit layer 65 is inverted at sufficiently low current, and a magnetic field can be effec-

tively applied to the ferromagnetic layer 64. Therefore, compared to the conventional structure shown in Figure 4, the magnetization direction of the magnetic memory cell 51 can be altered at sufficiently low current. Therefore, by constituting the closed magnetic circuit layer 65 of a material of high permeability, it is effective to reduce the recording current.

[0116] Another example of the magnetic memory cell 51 shown in Figure 8 is shown in Figure 10. The structure shown in Figure 9 differs from the structure shown in Figure 8 in that the ferromagnetic layer 64 and the closed magnetic circuit layer 65 are connected via the metal layer 67. The thickness of the metal layer 67 is set such that the ferromagnetic layer 64 and the closed magnetic circuit layer 65 are exchange coupled. Therefore, when carrying out the rewriting of information on the magnetic memory cell 51 in the above manner, in other magnetic memory cells than the magnetic cell 51, in which rewriting of information is not performed, the respective magnetizations of the ferromagnetic layer 64 and the closed magnetic circuit layer 65 surely form a closed magnetic circuit by the antiferromagnetic coupling via the metal layer 67.

[0117] In the present embodiment, as a magnetic memory cell having a closed magnetic circuit structure, two examples adopting the MTJ device have been shown; however, the present invention is not limited to the above, and the magnetic memory cell having other closed magnetic circuit structure may be adopted. In the present embodiment, the word line is provided on the bit line, however, it may be provided below the MTJ device. Also, it may be arranged so as to insulate the bit line from the MTJ device, or the bit line and the word line are exchanged, or the bit line or the word line are separately provided for recording and reading out. The bit line, word line, and the closed magnetic circuit structure are not limited to the above.

[0118] As described, the first magnetic tunnel junction device of the present invention including at least a first magnetic layer, an insulating layer and a second magnetic layer which are laminated in this order, is characterized by further including: a third magnetic layer formed on an opposite side of an insulating layer forming side of the first or second magnetic layer via a metal layer with a spacing formed at a central portion, wherein the first or second magnetic layer and the third magnetic layer form a closed magnetic circuit.

[0119] According to the foregoing arrangement, the magnetization of the third magnetic layer serving as the closed magnetic circuit layer and the first or second magnetic layer form a closed loop; and thus the generation of the magnetic poles at both end portions can be avoided. As described, according to the MTJ device of the described structure, effects of the magnetic poles generated at both end portions can be avoided. Thus, a stable magnetization state as recorded can be maintained even for a miniaturized pattern. Additionally, since the memory layer of the ferromagnetic layer has

a closed magnetic circuit structure, stable magnetization state as recorded can be ensured against an external leakage magnetic field.

[0120] The second magnetic tunnel junction device having the structure of the first magnetic tunnel junction device is characterized in that at least one lead line is formed in the spacing between the third magnetic layer and the first or second magnetic layer.

[0121] According to the foregoing structure, by forming the lead line in the spacing at the central portion between the first or second magnetic layer and the third magnetic layer, a current value required for inverting the magnetization direction of the magnetic layer and the closed magnetic circuit layer can be reduced, and the power consumption of the magnetic memory adopting the MTJ device can be reduced.

[0122] The third magnetic tunnel junction device of the present invention which includes at least the first magnetic layer, the first insulating layer, the second magnetic layer, the second insulating layer and the third magnetic layer which are laminated is characterized by including:

a fourth magnetic layer formed on a first insulating layer laminating side or a second insulating layer laminating side of the second magnetic layer via a metal layer with a spacing at a central portion, and the second magnetic layer and the fourth magnetic layer form a closed magnetic circuit.

[0123] According to the described arrangement, a high resistance change ratio can be obtained, and the effects of the magnetic poles generated at both end portions can be reduced. Thus, a stable magnetization state as recorded can be maintained even for a miniaturized pattern. Additionally, since the memory layer of the ferromagnetic layer has a closed magnetic circuit structure, stable magnetization state as recorded can be ensured against an external leakage magnetic field.

[0124] The fourth magnetic tunnel junction device of the present invention having the structure of the third magnetic tunnel junction device is characterized by further including a first antiferromagnetic layer which is exchange-coupled with the first magnetic layer, and a second antiferromagnetic layer which is exchange coupled with the third magnetic layer.

[0125] The fifth magnetic tunnel junction device of the present invention having the structure of the fourth magnetic tunnel junction device is characterized in that an exchange coupling between the first antiferromagnetic layer and the first magnetic layer disappears at different temperature from a temperature at which an exchange coupling between the second antiferromagnetic layer and the third magnetic layer disappears.

[0126] The sixth magnetic tunnel junction device having the structure of the first or second magnetic tunnel junction device is characterized in that:

at least the first magnetic layer or the second magnetic layer is composed of two or more ferromagnetic layers which are antiferromagnetically coupled via a

metal layer.

[0127] According to the above arrangement, in order to read out information in the foregoing manner, i.e., based on changes in resistance depending on whether the magnetization direction of the closed loop composed of the first or third magnetic layer and the second magnetic layer (closed magnetic circuit layer), and the magnetization direction of the ferromagnetic layer and the first or third magnetic layer are parallel to or antiparallel to one another, it is required to fix the magnetization direction of the ferromagnetic layer in the same direction as the first or third magnetic layer.

[0128] According to the above arrangement, the magnetization direction of the ferromagnetic layer and the first or third magnetic layer can be fixed with a single treatment or a magnetic field of the same direction. As a result, the process of reading out can be simplified.

[0129] With the foregoing preferred embodiment, the first magnetic layer composed of two ferromagnetic layers, and the third magnetic layer of a single ferromagnetic layer are adopted. However, the present invention is not limited to this arrangement as long as the condition that the respective numbers of magnetic layers differ between the two fixed layers by one.

[0130] In the present embodiment, the same antiferromagnetic material may be used for the antiferromagnetic layer 41 and the antiferromagnetic layer 49.

[0131] The seventh magnetic tunnel junction device of the present invention having any of the third through sixth magnetic tunnel junction devices, is characterized in that:

at least one lead line is formed in the spacing between the second magnetic layer and the fourth magnetic layer.

[0132] According to the described arrangement, by forming the lead line in the spacing between the second magnetic layer and the fourth magnetic layer, a current value required for inverting the magnetization direction of the second magnetic layer and the fourth magnetic layer (closed magnetic circuit layer) can be reduced.

[0133] The first magnetic memory of the present invention is characterized by adopting a magnetic tunnel junction device of the present invention which includes at least a first magnetic layer, an insulating layer and a second magnetic layer which are laminated in this order and further includes a third magnetic layer serving as a closed magnetic circuit layer formed on different side of an insulating layer forming side of the first magnetic layer or the second magnetic layer, wherein the third magnetic layer is formed via a metal layer so as to have a spacing at a central portion, and the third magnetic layer forms a closed magnetic circuit with the first magnetic layer or the second magnetic layer.

[0134] According to the foregoing arrangement, the magnetization of the third magnetic layer serving as the closed magnetic circuit layer and the first or second magnetic layer form a closed loop; and thus the generation of the magnetic poles at both end portions can be

avoided. As described, according to the MTJ device of the described structure, effects of the magnetic poles generated at both end portions can be eliminated. Thus, a stable magnetization state as recorded can be maintained for a miniaturized pattern. Additionally, since the memory layer of the ferromagnetic layer has a closed magnetic circuit structure, a stable magnetization state as recorded can be ensured against an external leakage magnetic field. Therefore, a power consumption of the magnetic memory adopting the MTJ device can be reduced.

[0135] The second magnetic memory of the present invention having the structure of the first magnetic memory is characterized by including at least one lead line in the spacing between the first or second magnetic layer and the third magnetic layer.

[0136] The third magnetic memory of the present invention is characterized by including a magnetic tunnel junction device which includes at least the first magnetic layer, the first insulating layer, the second magnetic layer, the second insulating layer and the third magnetic layer which are laminated, and further includes a fourth magnetic layer formed on a first insulating layer laminating side or a second insulating layer laminating side of the second magnetic layer via a metal layer with a spacing at a central portion, wherein the second magnetic layer and the fourth magnetic layer forms a closed magnetic circuit.

[0137] According to the described arrangement, a high resistance change ratio is obtained, and the effects of the magnetic poles generated at the end portion can be reduced. Thus, a stable magnetization state as recorded can be maintained for a miniaturized pattern. As a result, a magnetic memory of an improved integration can be realized, and a power consumption of the magnetic memory can be reduced.

[0138] The access method of the magnetic memory cell of the present invention is characterized by including the steps of:

forming a closed magnetic circuit on a magnetic layer for storing a memory of a magnetic memory cell; placing a first current line in a closed magnetic circuit composed of the magnetic layer and the closed magnetic circuit layer, and a second current line outside the closed magnetic circuit; changing the magnetization direction of the magnetic layer by applying such current to the first current line that the magnetization of the closed magnetic circuit layer is inverted but the magnetization of the magnetic layer is not inverted, and applying such current to the second current line that the magnetization of the magnetic layer is not inverted by the second current line alone, but the magnetization of the magnetic layer is inverted by a synthetic magnetic field with the first current line.

[0139] According to the described access method of

the magnetic memory cell, by controlling the magnetic characteristics of the ferromagnetic layer and the closed magnetic circuit layer and the level of current flowing through the first current line (bit line) and the second current line (word line), access to only one magnetic memory cell is permitted, and a required recording current can be reduced. Further, the effects of magnetic poles at both end portions on the magnetic memory cell can be suppressed. As a result, a stable magnetization state can be ensured even for a miniaturized pattern, and a highly integrated magnetic memory can be realized. Additionally, by adopting the closed magnetic circuit layer structure for the memory layer, a stable magnetization state as recorded can be ensured against an external leakage magnetic field. Further, a power consumption of the magnetic memory can be reduced.

[0140] Further, the first current line is formed within the closed magnetic circuit layer structure formed by the magnetic layer (ferromagnetic layer 64) and the closed magnetic circuit layer, the magnetization of the closed magnetic circuit layer can be inverted at sufficiently low current, thereby effectively applying the magnetic layer.

[0141] The first magnetic cell of the present invention adopting the above access method is characterized by including a magnetic tunnel junction device which includes a first magnetic layer, an insulating layer, and a second magnetic layer which are laminated in this order, wherein at least the closed magnetic circuit layer is formed on an opposite side of an insulating layer forming side of the first or second magnetic layer with a spacing at a central portion, and the first or second magnetic layer and the closed magnetic circuit layer form a closed magnetic circuit.

[0142] The second magnetic cell of the present invention adopting the above access method is characterized by including a magnetic tunnel junction device which includes a first magnetic layer, an insulating layer, and a second magnetic layer which are laminated in this order, wherein at least the closed magnetic circuit layer is formed on an opposite side of an insulating layer forming side of the first or second magnetic layer via a metal layer with a spacing at a central portion, and the first or second magnetic layer and the closed magnetic circuit layer form a closed magnetic circuit.

[0143] The invention being thus described, it will be obvious that the same may be varied in many ways. Such variations are not to be regarded as a departure from the spirit and scope of the invention, and all such modification as would be obvious to one skilled in the art are intended to be included within the scope of the following claims.

Claims

1. A magnetic tunnel junction device comprising at least a first magnetic layer, an insulating layer and a second magnetic layer which are laminated in this

order, characterized by further comprising:

a third magnetic layer (17) formed on an opposite side of an insulating layer forming side of said first or second magnetic layer via a metal layer with a spacing formed at a central portion, wherein said first or second magnetic layer and said third magnetic layer form a closed magnetic circuit.

2. The magnetic tunnel junction device as set forth in claim 1, characterized in that:

at least one lead line is formed in said spacing between said first or second magnetic layer and said third magnetic layer.

3. The magnetic tunnel junction device as set forth in claim 1, characterized in that:

a thickness of the metal film is set to such thickness that said first or second magnetic layer and the third magnetic layer are antiferromagnetically coupled.

4. The magnetic tunnel junction device as set forth in any one of claims 1 through 3, characterized in that:

said metal layer is formed on both end portions.

5. The magnetic tunnel junction device as set forth in any one of claims 1 through 4, characterized in that:

said metal film is made of a material selected from the group consisting of Ru, Cr, Cu and alloys thereof.

6. A magnetic memory adopting a magnetic tunnel junction device, characterized by comprising at least a first magnetic layer, an insulating layer and a second magnetic layer which are laminated in this order, and a third magnetic layer formed on an opposite side of an insulating layer forming side of the first or second magnetic layer via a metal layer with a spacing at a central portion, wherein said first or second magnetic layer and said third magnetic layer form a closed magnetic circuit.

7. The magnetic memory as set forth in claim 6, characterized in that at least a lead line is formed in a spacing between said first or second magnetic layer and said third magnetic layer.

8. A magnetic tunnel junction device comprising a first magnetic layer, a first insulating layer, a second magnetic layer, a second insulating layer and a third magnetic layer which are laminated, characterized by further comprising:

a fourth magnetic layer (36) formed on either a first insulating layer forming side or a second

insulating layer forming side of said second magnetic layer via a metal layer with a spacing at a central portion,
wherein said second magnetic layer and said fourth magnetic layer form a closed magnetic circuit.

9. The magnetic tunnel junction device as set forth in claim 8, characterized by further comprising:

a first antiferromagnetic layer (31) which is exchange coupled with the first magnetic layer, and
a second antiferromagnetic layer (36) which is exchange coupled with the third magnetic layer.

10. The magnetic tunnel junction device as set forth in claim 9, characterized in that:

an exchange coupling between said first antiferromagnetic layer and the first magnetic layer disappears at different temperature from a temperature at which an exchange coupling between said second antiferromagnetic layer and said third magnetic layer disappears.

11. The magnetic tunnel junction device as set forth in any one of claim 9 or 10, characterized in that:

at least either the first magnetic layer (42) or the third magnetic layer (48) is constituted by at least two ferromagnetic layers (42a, 42c) which are antiferromagnetically coupled via a second metal layer (42b).

12. The magnetic tunnel junction device as set forth in any one of claims 8 through 11, characterized in that:

at least one lead line is formed in a spacing between the second magnetic layer and the fourth magnetic layer.

13. The magnetic tunnel junction device as set forth in any one of claims 8 through 12, characterized in that:

a film thickness of said metal layer is adjusted such that said second magnetic layer and said fourth magnetic layer are antiferromagnetically coupled.

14. The magnetic tunnel junction device, as set forth in any one of claims 9 through 13, characterized in that:

respective magnetizations of said first magnetic layer and said first antiferromagnetic layer, and respective magnetizations of said third magnetic layer and said second antiferromagnetic layer are exchange coupled, which are fixed in opposite directions.

15. The magnetic tunnel junction device, as set forth in any one of claims 9 through 14, characterized in that:

respective number of magnetic layers of said first magnetic layer and said third magnetic layer differ by one.

16. The magnetic tunnel junction device set forth in claim 15, characterized in that:

said third magnetic layer is a single layer, and said first magnetic layer includes a first ferromagnetic layer and a third ferromagnetic layer which are antiferromagnetically coupled via a second metal layer, and a magnetization direction of said first ferromagnetic layer is fixed in a magnetization direction of said third magnetic layer.

17. The magnetic tunnel junction device as set forth in any one of claims 8 through 16, characterized in that:

said metal film is made of a material selected from the group consisting of Ru, Cr, Cu and alloys thereof.

18. A magnetic memory characterized by adopting a magnetic tunnel junction device which comprises a first magnetic layer, a first insulating layer, a second insulating layer and a third insulating layer which are laminated, and further comprises a fourth magnetic layer formed either a first insulating layer forming side or a second insulating layer forming side of said second magnetic layer via a metal layer with a spacing formed at a central portion,

wherein said second magnetic layer and the fourth magnetic layer form a closed magnetic circuit.

19. An access method of a magnetic memory cell characterized by comprising the steps of:

forming a closed magnetic circuit on a magnetic layer for storing a memory of a magnetic memory cell;

placing a first current line (52) in a closed magnetic circuit composed of the magnetic layer and the closed magnetic circuit layer, and a second current line (53) outside the closed magnetic circuit;

changing the magnetization direction of the magnetic layer by applying such current to the first current line that the magnetization of the closed magnetic circuit layer is inverted but the magnetization of the magnetic layer is not inverted, and applying such current to the second current line that the magnetization of the magnetic layer is not inverted by the second current

line alone, but the magnetization of the magnetic layer is inverted by a synthetic magnetic field with the first current line.

20. A magnetic memory cell adopting an access method which comprises the steps of:

forming a closed magnetic circuit on a magnetic layer for storing a memory of a magnetic memory cell; placing a first current line in a closed magnetic circuit composed of the magnetic layer and the closed magnetic circuit layer, and a second current line outside the closed magnetic circuit; and changing the magnetization direction of the magnetic layer by applying such current to the first current line that the magnetization of the closed magnetic circuit layer is inverted but the magnetization of the magnetic layer is not inverted, and applying such current to the second current line that the magnetization of the magnetic layer is not inverted by the second current line alone, but the magnetization of the magnetic layer is inverted by a synthetic magnetic field with the first current line, said magnetic memory cell, characterized by comprising a magnetic tunnel junction device which includes a first magnetic layer, an insulating layer, and a second magnetic layer which are laminated in this order, wherein at least the closed magnetic circuit layer is formed on an opposite side of an insulating layer forming side of said first or second magnetic layer with a spacing at a central portion, and the first or second magnetic layer and the closed magnetic circuit layer form a closed magnetic circuit.

21. The magnetic memory cell as set forth in claim 20, characterized in that:

said closed magnetic circuit layer is made of a material of a small coercive force than the first or second magnetic layer which forms a closed magnetic circuit with the closed magnetic circuit layer.

22. A magnetic memory cell adopting an access method, characterized by comprising the steps of:

forming a closed magnetic circuit on a magnetic layer for storing a memory of a magnetic memory cell; placing a first current line in a closed magnetic circuit composed of the magnetic layer and the closed magnetic circuit layer, and a second current line outside the closed magnetic circuit; and changing the magnetization direction of the magnetic layer by applying such current to the first current line that the magnetization of the closed magnetic circuit layer is inverted but the magnetization of the magnetic

layer is not inverted, and applying such current to the second current line that the magnetization of the magnetic layer is not inverted by the second current line alone, but the magnetization of the magnetic layer is inverted by a synthetic magnetic field with the first current line, said magnetic memory cell, characterized by comprising a magnetic tunnel junction device which includes a first magnetic layer, an insulating layer, and a second magnetic layer which are laminated in this order, wherein at least the closed magnetic circuit layer is formed on an opposite side of an insulating layer forming side of said first or second magnetic layer via a metal layer with a spacing at a central portion, and the first or second magnetic layer and the closed magnetic circuit layer form a closed magnetic circuit.

23. The magnetic memory cell as set forth in claim 22, characterized in that:

a film thickness of said metal layer is adjusted such that the closed magnetic circuit layer and the first or second magnetic layer which forms a closed magnetic circuit with the closed magnetic circuit layer are ferromagnetically coupled.

FIG.1

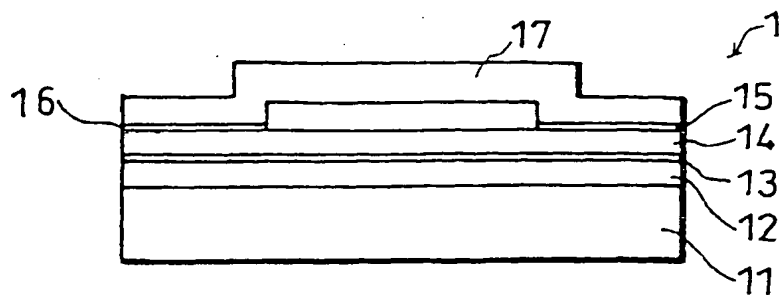


FIG.2

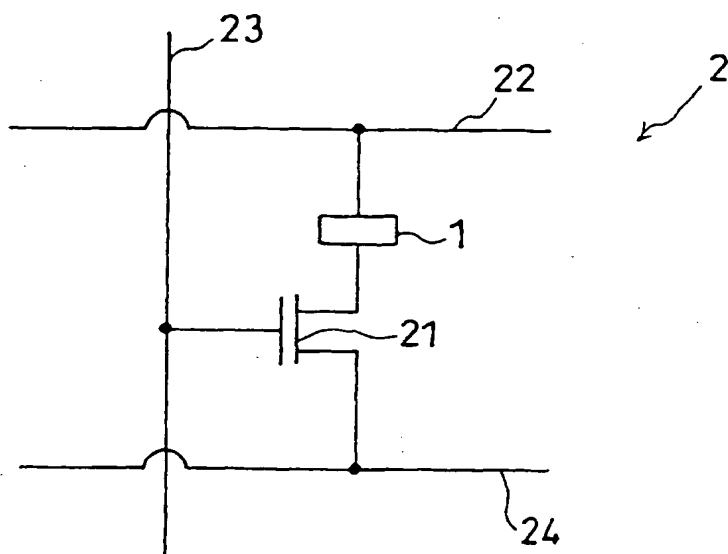


FIG.3

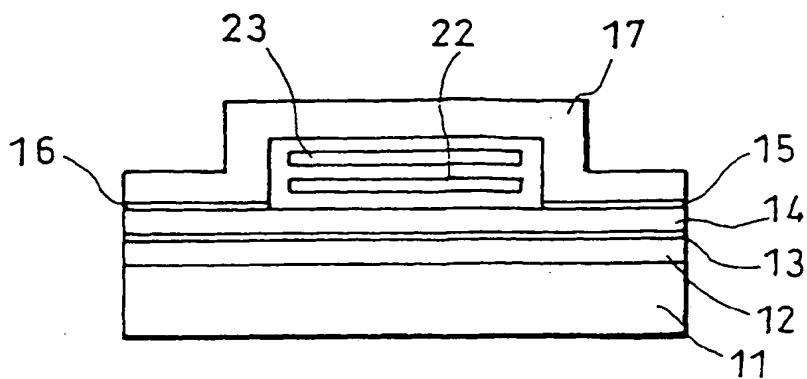


FIG.4

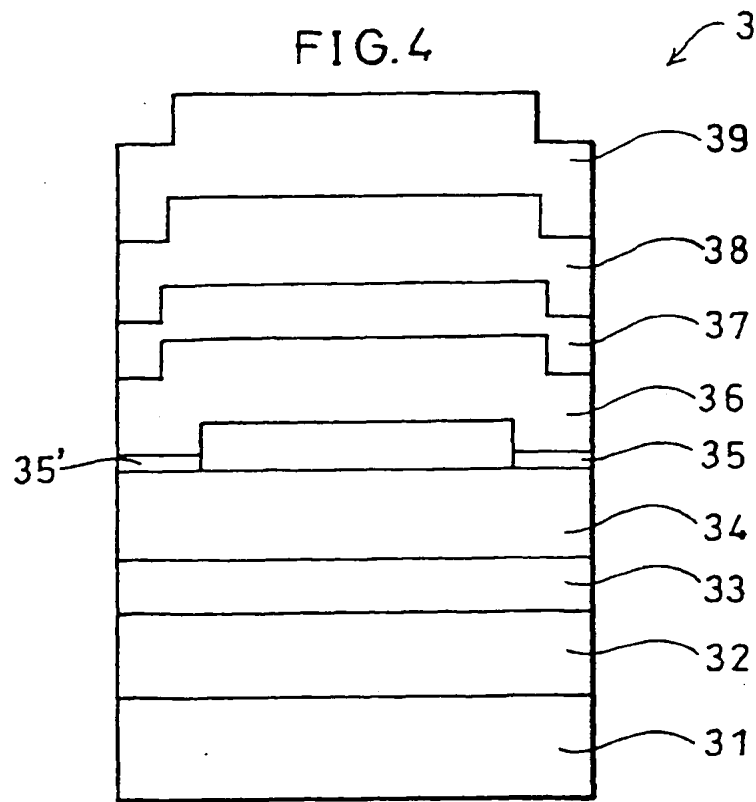


FIG.5

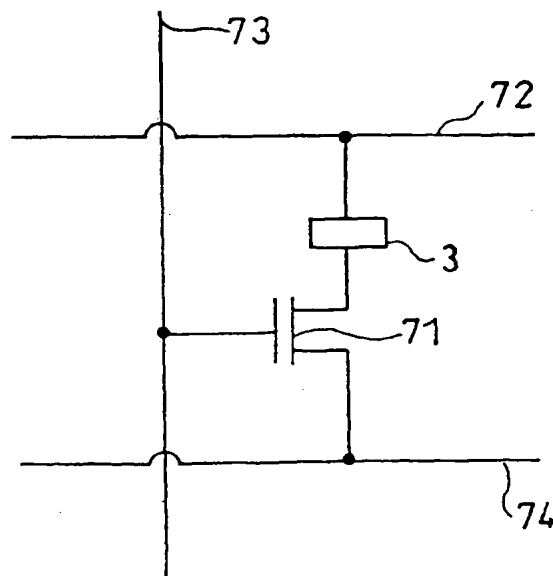


FIG. 6

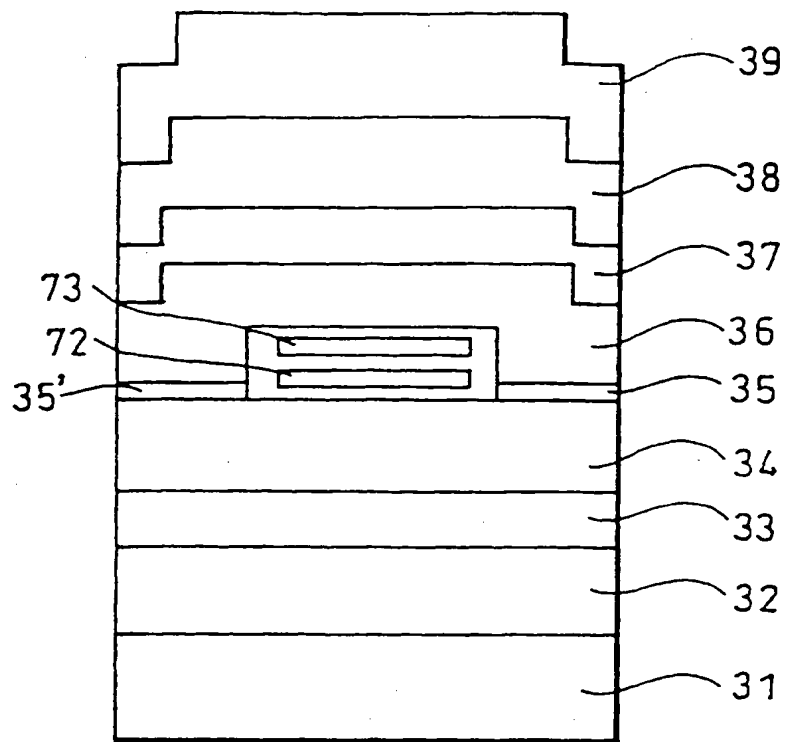


FIG. 7

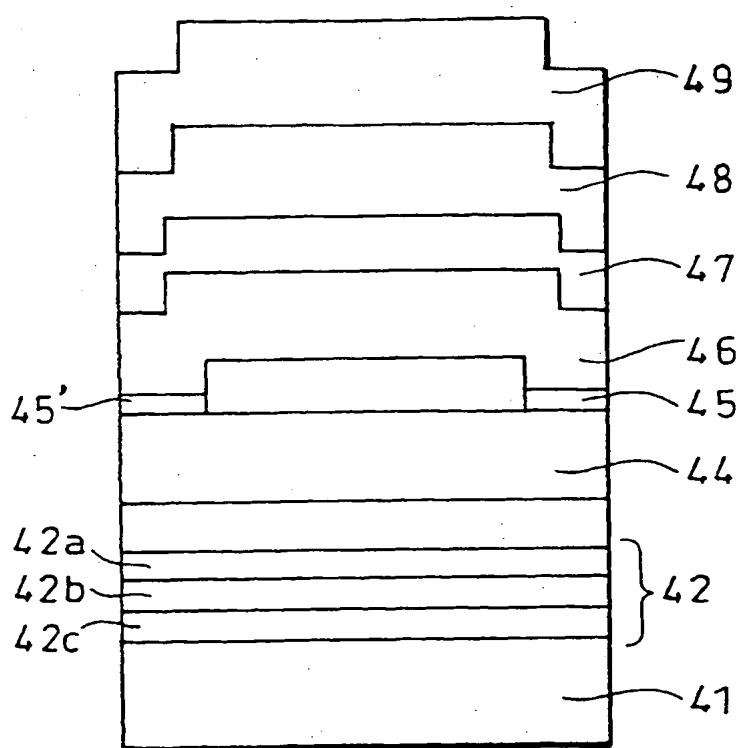


FIG. 8

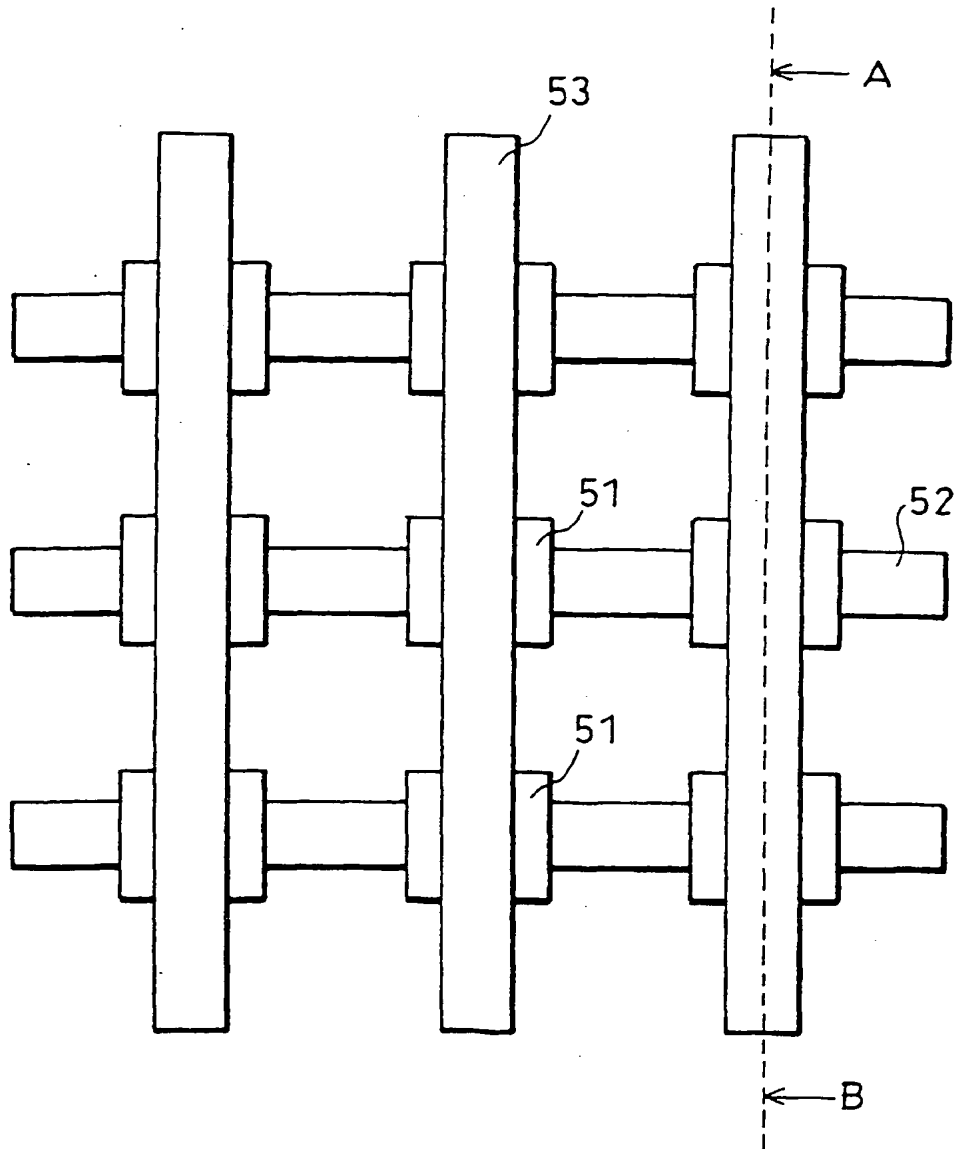


FIG. 9

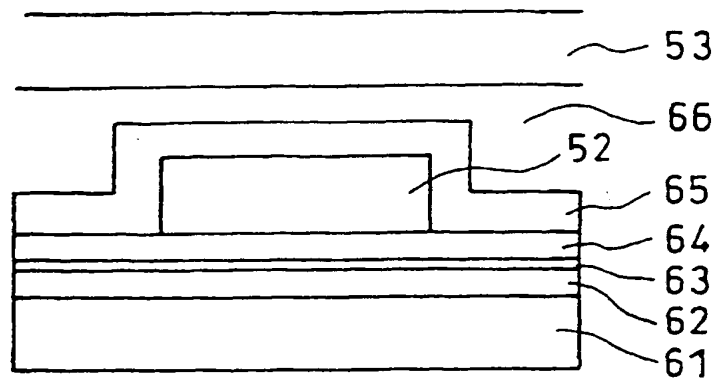


FIG. 10

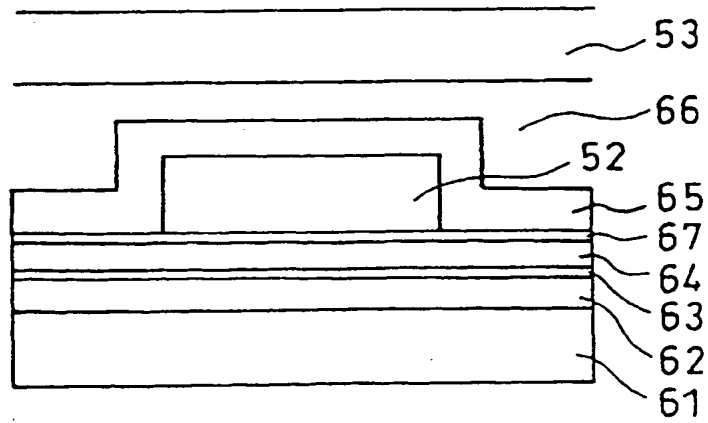


FIG. 11

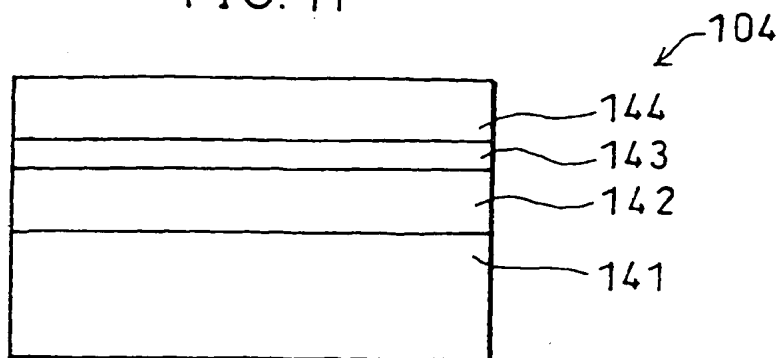


FIG. 12 (a)

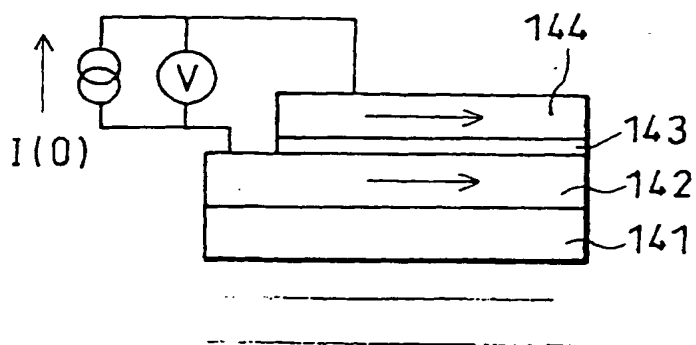


FIG. 12 (b)

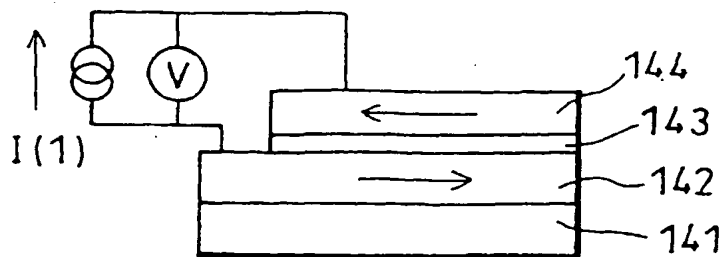


FIG.13

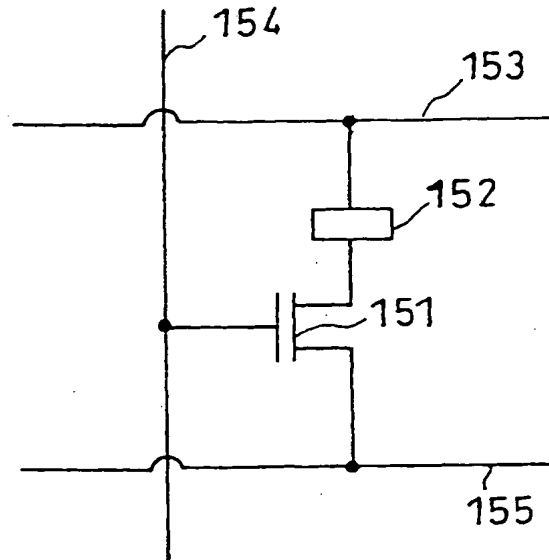
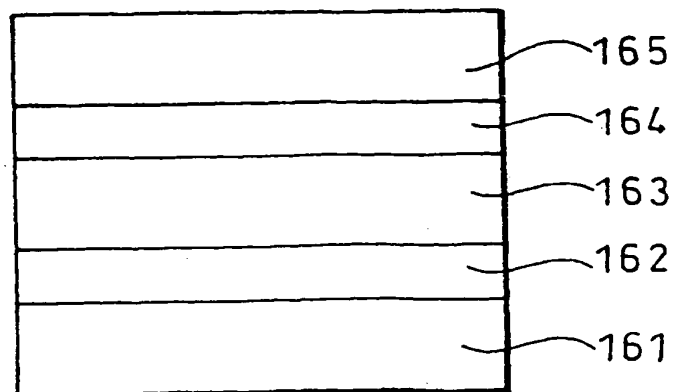
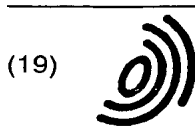


FIG.14





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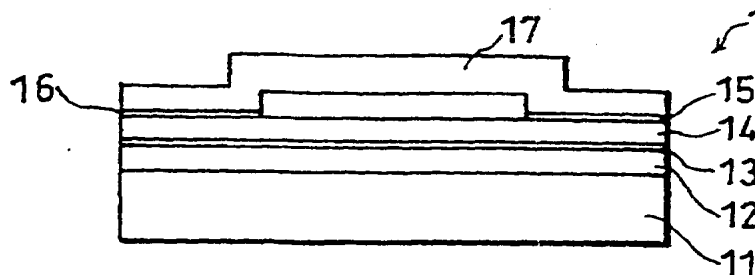
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81667 München (DE)

(54) Magnetic tunnel junction device, magnetic memory adopting the same, magnetic memory cell and access method of the same

(57) A closed magnetic circuit layer is formed on a ferromagnetic layer serving as a memory layer of a magnetic tunnel junction device, in such a manner that a

closed magnetic circuit layer is formed via a metal layer with a spacing at a central portion. With this structure, stable magnetization state can be ensured even for a miniaturized pattern.

FIG.1





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EUROPEAN SEARCH REPORT

Application Number
EP 00 12 6994

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The present search report has been drawn up for all claims			
Place of search THE HAGUE		Date of completion of the search 19 November 2001	Examiner Degraeve, L
<p>CATEGORY OF CITED DOCUMENTS</p> <p>X : particularly relevant if taken alone Y : particularly relevant if combined with another document of the same category A : technological background O : non-written disclosure P : intermediate document</p> <p>T : theory or principle underlying the invention E : earlier patent document, but published on, or after the filing date D : document cited in the application L : document cited for other reasons Δ : member of the same patent family, corresponding document</p>			

EPO FORM 1503 03.82 (P04C01)



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Application Number
EP 00 12 6994

CLAIMS INCURRING FEES

The present European patent application comprised at the time of filing more than ten claims.

- ☐ Only part of the claims have been paid within the prescribed time limit. The present European search report has been drawn up for the first ten claims and for those claims for which claims fees have been paid, namely claim(s):
- ☐ No claims fees have been paid within the prescribed time limit. The present European search report has been drawn up for the first ten claims.

LACK OF UNITY OF INVENTION

The Search Division considers that the present European patent application does not comply with the requirements of unity of invention and relates to several inventions or groups of inventions, namely:

see sheet B

- ☒ All further search fees have been paid within the fixed time limit. The present European search report has been drawn up for all claims.
- ☐ As all searchable claims could be searched without effort justifying an additional fee, the Search Division did not invite payment of any additional fee.
- ☐ Only part of the further search fees have been paid within the fixed time limit. The present European search report has been drawn up for those parts of the European patent application which relate to the inventions in respect of which search fees have been paid, namely claims:
- ☐ None of the further search fees have been paid within the fixed time limit. The present European search report has been drawn up for those parts of the European patent application which relate to the invention first mentioned in the claims, namely claims:



European Patent
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EUROPEAN SEARCH REPORT

Application Number
EP 00 12 6994

DOCUMENTS CONSIDERED TO BE RELEVANT			
Category	Citation of document with indication, where appropriate, of relevant passages	Relevant to claim	CLASSIFICATION OF THE APPLICATION (Int.Cl.7)
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The present search report has been drawn up for all claims			
Place of search THE HAGUE		Date of completion of the search 19 November 2001	Examiner Degraeve, L
CATEGORY OF CITED DOCUMENTS X : particularly relevant if taken alone Y : particularly relevant if combined with another document of the same category A : technological background O : non-written disclosure P : intermediate document		T : theory or principle underlying the invention E : earlier patent document, but published on, or after the filing date D : document cited in the application L : document cited for other reasons & : member of the same patent family, corresponding document	

EPO FORM 1503 03 82 (P4/C01)



European Patent
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LACK OF UNITY OF INVENTION
SHEET B

Application Number
EP 00 12 6994

The Search Division considers that the present European patent application does not comply with the requirements of unity of invention and relates to several inventions or groups of inventions, namely:

1. Claims: 1-18, 20-23

Magnetic tunnel junction and its use in a magnetic memory

2. Claim : 19

Access method for a memory cell

**ANNEX TO THE EUROPEAN SEARCH REPORT
ON EUROPEAN PATENT APPLICATION NO.**

EP 00 12 6994

This annex lists the patent family members relating to the patent documents cited in the above-mentioned European search report. The members are as contained in the European Patent Office EDP file on
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19-11-2001

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048
OSMM&N File No. 242751US2
Serial No. 10/660,605

Dept.: IP-I

By: MJS/mka

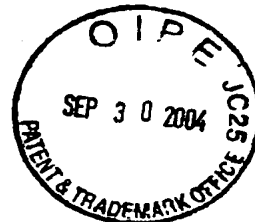
In the matter of the Application of: Joichiro EZAKI, et al.

For: MAGNETORESISTIVE EFFECT ELEMENT, MAGNETIC MEMORY
DEVICE AND METHOD OF FABRICATING THE SAME

Due Date: 10/11/2004

The following has been received in the U.S. Patent Office on the date stamped hereon:

- Dep. Acct. Order Form
- Information Disclosure Statement
- Cited References (1)
- Search Report EUROPEAN
- PTO-1449



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